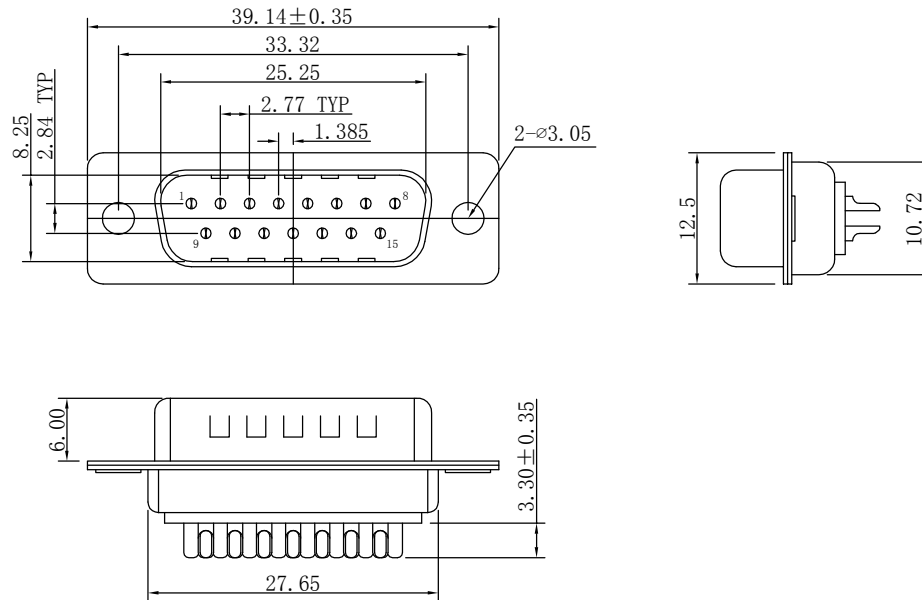


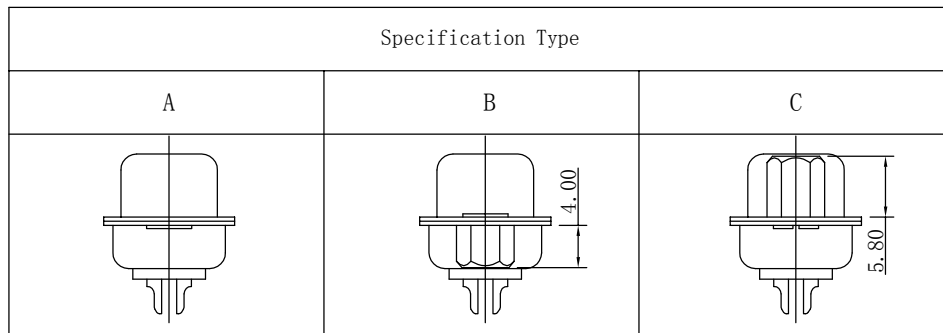
The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

RoHS

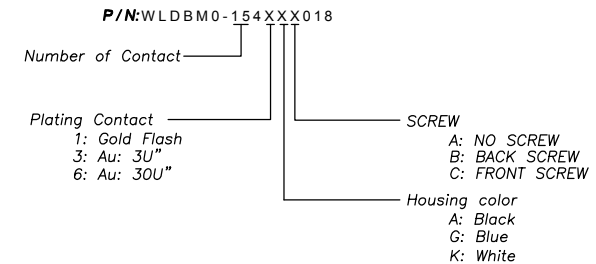




- NOTE
- 1.MATERIAL:
 - 1.1 INSULATOR: PBT+30% GLASS FIBER UL94V-0
 - 1.2 TERMINAL: COPPER ALLOY BRASS T=0.20±0.02mm
GOLD FLASH ON CONTACT AREA AND TIN 80U" ON SOLDER TAIL; NICKEL:30U" ON THE BASE
 - 1.3 SHELL: FRONT SHELL:SPCC-SD T=0.35±0.02mm
PLATING:Cu50u"/Ni50u" ;
REAR SHELL:SPCC-SD T=0.35±0.02mm
PLATING:Cu50u"/Tin80u"
 - 1.4 BOARD LOCK: COPPER ALLOY, PLATING: Cu50u"/Ni40u"
 - 2.ELECTRICAL:
 - 2.1 INSULATOR RESISTANCE: 1000MEGOHMS MIN AT 500V DC.
 - 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC R.M.S
 - 2.3 VOLTAGE TATING: 40V AC (RMS) CONTINUOUS MAX.
 - 2.4 CURRENT RATING: 3A.
 - 2.5 CONTGACT RESISTANCE: 30 MILLIOHMS MAX.
 - 3.MECHANICAL
 - 3.1 INSERTION/EXTRACTION FORCE PER CONTACT: 5.0Kgf Max
0.45Kgf Min.
 - 4.ENVIRONMENTAL
 - TEMPERATURE RANGE:-55°C TO + 105°C.

Specification Type



ORDER INFORMTION



REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Technology Co., Ltd	
A0	NEW RELEASE	21.01.13		LINEAR	1:1	Wang_jr	2023.5.23	WLDBM0-154XXX018	ENDE05		
A1	ADD MATERIAL THICK AND COLOR	2023. 5. 23		ANGLES							
			UNIT:mm	0.00±0.25	X'±3'	DESIGNER	Ou_jian	2023.5.23	TITLE:		
			SIZE: A4	0.000±0.10	X'X' ±2'	DRAWN	Hou-lanxuan	2023.5.23	DB 15P Male Soldering		
										REV: A1	SHEET: 1/1